



PC 1734\$
C06 Rec'd PCT/PTO 30 SEP 2005

PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q88153

Koji WATANABE, et al.

Appln. No.: 10/541,586

Group Art Unit: 1734

Confirmation No.: 1996

Examiner: Not yet assigned

Filed: July 7, 2005

September 30, 2005

For: CURING RESIN COMPOSITION, ADHESIVE EPOXY RESIN PASTE, ADHESIVE EPOXY RESIN SHEET, CONDUCTIVE CONNECTION PASTE, CONDUCTIVE CONNECTION SHEET, AND ELECTRONIC COMPONENT JOINED BODY

SUBMISSION OF EXECUTED DECLARATION

MAIL STOP MISSING PARTS

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

In view of the application filed on July 7, 2005 without the appropriate executed documents, and since Applicant's attorney has not yet received the "Notice to File Missing Parts of Nonprovisional Application filed under 37 CFR 1.53(b) - Filing Date Granted," for the above application, Applicant submits herewith a copy of the Declaration for the above identified application properly executed by the inventors.

10/03/2005 HLE333 00000044 10541586

01 FC:1051 130.00 OP

02/27/2006 THOLLAND 00000004 10541586

01 FC:1617 130.00 OP

Adjustment date: 02/27/2006 THOLLAND
10/03/2005 HLE333 00000044 10541586
01 FC:1051 -130.00 OP

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